£Yŀjb´? `Ã'UbX'5`YI 'Ni b[Yf'

n-type doping of oxides by hydrogen

Çetin Kılıç^{a)} and Alex Zunger^{b)} National Renewable Energy Laboratory, Golden, Colorado 80401

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First-principles total-energy calculations suggest that interstitial hydrogen impurity forms a *shallow* donor in SnO_2 , CdO, and ZnO, but a deep donor in MgO. We generalize this result to other oxides by recognizing that there exist a "hydrogen pinning level" at about $3.0\pm0.4~eV$ below vacuum. Materials such as Ag_2O , HgO, CuO, PbO, PtO, IrO_2 , RuO_2 , PbO_2 , TiO_2 , WO_3 , Bi_2O_3 , Cr_2O_3 , Fe_2O_3 , Sb_2O_3 , Nb_2O_5 , Ta_2O_5 , $FeTiO_3$, and $PbTiO_3$, whose conduction band minimum (CBM) lie below this level (i.e., electron affinity>3.0±0.4 eV) will become conductive once hydrogen is incorporated into the lattice, without reducing the host. Conversely, materials such as BaO, NiO, SrO, HfO_2 , and Al_2O_3 , whose CBM lie above this level (i.e., electron affinity<3.0±0.4 eV) will remain nonconductive since hydrogen forms a deep impurity. © 2002 American Institute of Physics. [DOI: 10.1063/1.1482783]

Hydrogen is a ubiquitous impurity in most semiconductors, including elemental (e.g., Si), compound (e.g., GaAs) and wide gap (e.g., III-V nitrides and II-VI's) semiconductors. In these systems, hydrogen is known to be amphoteric, forming an acceptor level in n-type and a donor level in p-type materials. In contrast, hydrogen can lead to electron conduction in some wide gap oxides such as SnO₂ (Ref. 2) and ZnO (Ref. 3). These observations raise the question of what is the basic systematic at work here: if H can be incorporated into some materials, which one will be doped by H (i.e., become conductive) and which will not? Our firstprinciples study presented here show that SnO2 and CdO can be doped *n*-type by hydrogen incorporation, whereas H in MgO yield a deep level inside the band gap, so MgO is not doped by hydrogen. Our results indicate that the distinction between H as an *n*-type dopant and as a nondoping impurity depends on whether the "hydrogen pinning level," estimated to be located approximately at $3.0\pm0.4\,\mathrm{eV}$ below the vacuum level, is above the conduction band minimum (CBM) of the material (in which case H dopes it) or below the CBM of materials (in which case H is nondoping). Generally, low-electron-affinity oxides (whose CBM is close to a vacuum) will not be doped upon H incorporation. Likely examples include BaO, NiO, SrO, HfO₂, and Al₂O₃. Highelectron-affinity oxides, however, will be doped upon H incorporation. Likely examples include Ag₂O, HgO, CuO, PbO, PtO, IrO₂, RuO₂, PbO₂, TiO₂, WO₃, Bi₂O₃, Cr₂O₃, Fe₂O₃, Sb₂O₃, Nb₂O₅, Ta₂O₅, FeTiO₃ and PbTiO₃.

We calculate formation energies as well as (donor, acceptor) defect transition energies. The formation energy of interstitial H impurity in charge state q is given by

$$\Delta H_f^q(\mu_{\rm H}, E_F) = E(\text{host} + H^q) - E(\text{host})$$
$$- [\mu_{\rm H} + \frac{1}{2}E({\rm H_2})] + q(E_F + E_{\rm VBM}), \quad (1)$$

where $E(\alpha)$ denotes the total energy of the system α , μ_H is the hydrogen chemical potential, and E_F is the Fermi energy

measured from the valence band maximum (VBM) E_{VBM} . The defect transition level (q

calculated (+